UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/590,358	05/17/2007	Kenichi Kagawa	10294.0003	6738	
22852 7590 03/05/2009 FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER			EXAMINER		
LLP	ŕ	SKYLES, TIFNEY L			
901 NEW YORK AVENUE, NW WASHINGTON, DC 20001-4413			ART UNIT	PAPER NUMBER	
			2814		
			MAIL DATE	DELIVERY MODE	
			03/05/2009	PAPER	

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Office Action Summary		Application No.	Applicant(s)				
		10/590,358	KAGAWA ET AL.				
		Examiner	Art Unit				
		TIFNEY L. SKYLES	2814				
<i> Th</i> Period for Re	e MAILING DATE of this communication app eply	pears on the cover sheet with the c	orrespondence ado	lress			
WHICHEN - Extensions after SIX (6 - If NO perio - Failure to n Any reply n	ENED STATUTORY PERIOD FOR REPLY/FR IS LONGER, FROM THE MAILING DAY of time may be available under the provisions of 37 CFR 1.1 (a) MONTHS from the mailing date of this communication. If the from the mailing date of the communication is specified above, the maximum statutory period to eaply within the set or extended period for reply will, by statute specied by the Office later than three months after the mailing ent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim will apply and will expire SIX (6) MONTHS from , cause the application to become ABANDONEI	I. nely filed the mailing date of this cor D (35 U.S.C. § 133).				
Status							
1)⊠ Res	ponsive to communication(s) filed on <u>29 O</u>	ctober 2008.					
<i>7</i> —	· · · · · · · · · · · · · · · · · · ·	action is non-final.					
<i>,</i> —	ce this application is in condition for allowar	nce except for formal matters, pro	secution as to the	merits is			
•	ed in accordance with the practice under E						
Disposition o	of Claims						
4)⊠ Clai	m(s) <u>1-18</u> is/are pending in the application						
•	4a) Of the above claim(s) <u>13 and 15-18</u> is/are withdrawn from consideration.						
5)∐ Clai	5) Claim(s) is/are allowed.						
6)⊠ Clai	6)⊠ Claim(s) <u>1-12 and 14</u> is/are rejected.						
·	m(s) is/are objected to.						
•	m(s) <u>1-18</u> are subject to restriction and/or	election requirement.					
Application F	Papers						
	specification is objected to by the Examine	r					
•			o by the Examiner				
· —	10) The drawing(s) filed on 23 August 2006 is/are: a) accepted or b) objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a). Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).							
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.							
<i>,</i> —	r 35 U.S.C. § 119		, , , , , , , , , , , , , , , , , , , ,				
<u> </u>	<u>-</u>	mionity and an 3E LLC C \$ 110/a)	(d) or (f)				
•	12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).						
·	II b) Some * c) None of:	a hava haan wasaiyad					
	 1. ☐ Certified copies of the priority documents have been received. 2. ☐ Certified copies of the priority documents have been received in Application No 						
2				24			
3.∟	3. Copies of the certified copies of the priority documents have been received in this National Stage						
application from the International Bureau (PCT Rule 17.2(a)).							
* See the attached detailed Office action for a list of the certified copies not received.							
Attachment(s)							
	References Cited (PTO-892)	4) Interview Summary					
· =	Oraftsperson's Patent Drawing Review (PTO-948) n Disclosure Statement(s) (PTO/SB/08)	Paper No(s)/Mail Da 5) Notice of Informal P					
	s)/Mail Date	6) Other:	• •				

DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

2. Claims 1-4, 6-10, and 14 are rejected under 35 U.S.C. 102(e) as being anticipated by Combi et al (US 2004/0157364 A1).

Regarding Claim 1, Combi et al teach a semiconductor device cut into respective chips by a dicing process, comprising: a substrate 2a [Fig. 27] having an edge along a dicing line; a semiconductor element SB (shown in Fig. 20) formed on said substrate 2a; a jetty portion C (shown in Fig. 20) formed between said semiconductor element SB and said edge on said substrate 2a and having a laminated structure and including an insulating layer 13a and a conducting layer 15b formed on said insulating layer 13a; and an electrode pad 16' for signal input and output which is formed on said semiconductor element SB, and inside of the outermost wall of said jetty portion C.

Regarding Claim 2, Combi et al teach the semiconductor device according to claim 1, wherein said jetty portion **C** continuously extends along said edge in parallel.

Regarding Claim 3, Combi et al teach the semiconductor device according to claim 1, wherein said jetty portion **C** is formed so as to surround periphery of said semiconductor element **SB**.

Regarding Claim 4, Combi et al teach semiconductor device according to claim 1, wherein said semiconductor element SB includes an insulating layer 13a and a conducting layer 15b formed on said insulating layer 13a; said insulating layer 13a of said semiconductor element SB and said insulating layer 13a of said jetty portion C are formed in the same process; and said conducting layer 15b of said semiconductor element SB and said conducting layer 15b of said jetty portion C are formed in the same process.

Regarding Claim 6, Combi et al teach a semiconductor device comprising: a substrate 2a; a structure body SB supported by a fixing portion so as to form a space between said substrate 2a and said structure body SB; and a jetty portion C formed on said substrate 2a between the outer periphery of said substrate 2a and a portion of said structure body SB which is not supported by said fixing

Page 4

Regarding Claim 7, Combi et al teach the semiconductor device according to claim 6, wherein a plurality of said jetty portions **C** are formed so as to surround the outer periphery of said structure body **SB**.

Regarding Claim 8, Combi et al teach semiconductor device according to claim 6 further comprising an electrode pad **16'** for signal input and output which is formed on said structure body **SB** and inside of the outermost wall of said jetty portion **C**.

Regarding Claim 9, Combi et al teach the semiconductor device according to claim 8, wherein a plurality of said jetty portions C are formed so as to surround said structure body SB and said electrode pad 16' for signal input and output is arranged inside of an imaginary outer periphery which is formed by connecting the outermost walls of said jetty portions C.

Regarding Claim 10, Combi et al teach the semiconductor device according to claim 6, wherein said structure body SB includes a conducting layer 10 [Fig. 10] formed on said fixing portion; said fixing portion of said structure body SB and said insulating layer of said jetty portion C are formed in the same process; and

Application/Control Number: 10/590,358 Page 5

Art Unit: 2814

said conducting layer **15b** of said structure body **SB** and said conducting layer **15b** of said jetty portion **C** are formed in the same process.

Regarding Claim 14, Combi et al teach the semiconductor device according to claim 6, wherein an upper portion of inside area of said jetty portion **C** is opened.

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).
- 5. Claims 5, 11, and 12 are rejected under 35 U.S.C. 103(a) as being unpatentable over Combi et al in view of Mlcak et al (US 2003/0119220 A1).

Regarding Claim 5, Combi et al teach the semiconductor device according to claim 1, wherein said electrode pad 16' for signal input and output is formed on said conducting layer 12a of said semiconductor element SB, and wherein said jetty portion **C** includes a conducting layer **15b** [Fig. 10] but fail to teach an electrode pad for said jetty portion which is formed inside of said outermost wall on said conducting layer of the jetty portion, and which is connected electrically to said electrode pad for signal input and output in order to make potential difference between said conducting layer of said jetty portion and said conducting layer of said semiconductor element close to zero. However, Mlcak et al teach an electrode pad 24 [Fig. 1B] which is formed inside of said outermost wall on said conducting layer 14, and which is connected electrically 44 to said electrode pad for signal input and output in order to make potential difference between said conducting layer 14 and said conducting layer 12 of said semiconductor element 11 close to zero. Therefore, it would have been obvious to a person having ordinary skill in the art to combine Combi et al with Mlcak et al because it will improve functionality that is capable of operating at higher temperatures and in more corrosive environments [Para. 0004].

Regarding Claim 11, Combi et al teach the semiconductor device according to claim 10, wherein said electrode pad **16'** for signal input and output is formed on said conducting layer **12a** of said structure body **SB** but fail to teach said

Application/Control Number: 10/590,358

Art Unit: 2814

semiconductor device further comprising an electrode pad for said jetty portion which is formed on said conducting layer of said jetty portion, and which is connected electrically to said electrode pad for signal input and output in order to make potential difference between said conducting layer of said jetty portion and said conducting layer of said structure body close to zero. However, Mlcak et al teach said semiconductor device further comprising an electrode pad 24 [Fig. 1B] formed on said conducting layer 14, and which is connected electrically 44 to said electrode pad for signal input and output in order to make potential difference between said conducting layer 14 and said conducting layer 12 of said structure body 11 close to zero. Therefore, it would have been obvious to a person having ordinary skill in the art to combine Combi et al with Mlcak et al because it will improve functionality that is capable of operating at higher temperatures and in more corrosive environments [Para. 0004].

Page 7

Regarding Claim 12, Combi et al teach the limitations of claim 10 but fail to teach the semiconductor device according to claim 10 further comprising a potential equalizer in order to make potential difference between said conducting layer of said jetty portion and said conducting layer of said structure body close to zero. However, Mlcak et al teach the semiconductor device according to claim 10 further comprising a potential equalizer 44 [Fig. 1B] in order to make potential difference between said conducting layer and said conducting layer of said structure body close to zero. Therefore, it would have been obvious to a person

Application/Control Number: 10/590,358 Page 8

Art Unit: 2814

having ordinary skill in the art to combine Combi et al with Mlcak et al because it will improve functionality that is capable of operating at higher temperatures and in more corrosive environments [Para. 0004].

Response to Arguments

- 6. Applicant's arguments filed 10/29/2008 have been fully considered but they are not persuasive. The Applicant argues that Combi fails to teach claimed "jetty portion" however if one looks closely at Figure 27 one will see that "a jetty portion...including an insulating layer and a conducting layer formed on said insulating layer" is illustrated. Therefore the rejection still stands. The Applicant also argues that Combi is not prior art under 102(b) because the national stage application was filed February 28, 2005 wherein Combi's publication date is August 12, 2004. The Applicant is correct on this matter and the appropriate corrections have been made.
- 7. The Examiner acknowledges the Applicant's amendment of the title.

Conclusion

8. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within

TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to TIFNEY L. SKYLES whose telephone number is (571)270-5019. The examiner can normally be reached on Mon-Fri 7:30AM - 5:00PM EST.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (571) 272-1705. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Application/Control Number: 10/590,358 Page 10

Art Unit: 2814

/Wael M Fahmy/ Supervisory Patent Examiner, Art Unit 2814

TLS